

## 2A, 200V - 1000V Fast Recovery Surface Mount Rectifier

### FEATURES

- Glass passivated chip junction
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

### MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.027g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	2	A
$V_{RRM}$	200 - 1000	V
$I_{FSM}$	50	A
$T_{JMAX}$	150	°C
Package	SOD-128	
Configuration	Single die	



SOD-128



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)								
PARAMETER	SYMBOL	RS2DFS	RS2GFS	RS2JFS	RS2KFS	RS2MFS	UNIT	
Marking code on the device		RS2DFS	RS2GFS	RS2JFS	RS2KFS	RS2MFS		
Repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V	
Forward current	$I_F$	2					A	
Surge peak forward current, single half sine-wave superimposed on rated load	t = 8.3ms	$I_{FSM}$					50	A
	t = 1.0ms						140	A
Junction temperature	$T_J$	-55 to +150					°C	
Storage temperature	$T_{STG}$	-55 to +150					°C	

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	$^{\circ}\text{C/W}$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	73	$^{\circ}\text{C/W}$
Junction-to-case thermal resistance	$R_{\theta JC}$	14	$^{\circ}\text{C/W}$

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted)						
<b>PARAMETER</b>		<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage <sup>(1)</sup>	RS2DFS RS2GFS RS2JFS	$I_F = 1.0\text{A}, T_J = 25^{\circ}\text{C}$	$V_F$	0.93	-	V
		$I_F = 2.0\text{A}, T_J = 25^{\circ}\text{C}$		1.01	1.30	V
		$I_F = 1.0\text{A}, T_J = 125^{\circ}\text{C}$		0.78	-	V
		$I_F = 2.0\text{A}, T_J = 125^{\circ}\text{C}$		0.88	1.02	V
	RS2KFS RS2MFS	$I_F = 1.0\text{A}, T_J = 25^{\circ}\text{C}$		0.98	-	V
		$I_F = 2.0\text{A}, T_J = 25^{\circ}\text{C}$		1.06	1.30	V
		$I_F = 1.0\text{A}, T_J = 125^{\circ}\text{C}$		0.83	-	V
		$I_F = 2.0\text{A}, T_J = 125^{\circ}\text{C}$		0.93	1.05	V
Reverse current @ rated $V_R$ <sup>(2)</sup>		$T_J = 25^{\circ}\text{C}$	$I_R$	-	1	$\mu\text{A}$
		$T_J = 125^{\circ}\text{C}$		-	40	$\mu\text{A}$
Reverse recovery time	RS2DFS RS2GFS	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	$t_{rr}$	-	150	ns
	RS2JFS			-	250	ns
	RS2KFS RS2MFS			-	500	ns
Junction capacitance	RS2DFS RS2GFS RS2JFS	1MHz, $V_R = 4.0\text{V}$	$C_J$	11	-	pF
	RS2KFS RS2MFS			10	-	pF

**Notes:**

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
RS2xFS	SOD-128	14,000 / Tape & Reel

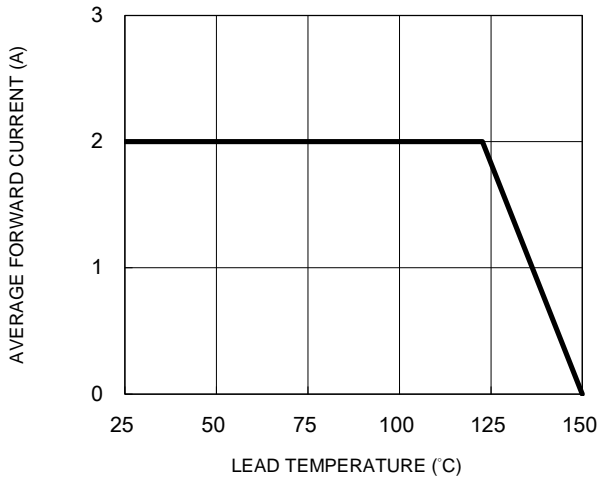
**Notes:**

1. "x" defines voltage from 200V(RS2DFS) to 1000V(RS2MFS)

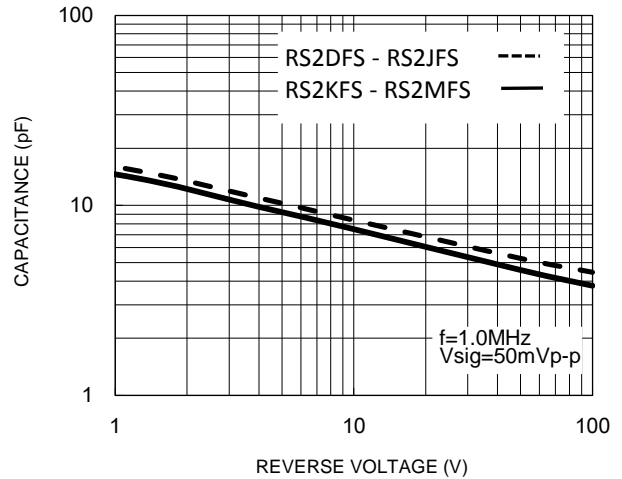
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

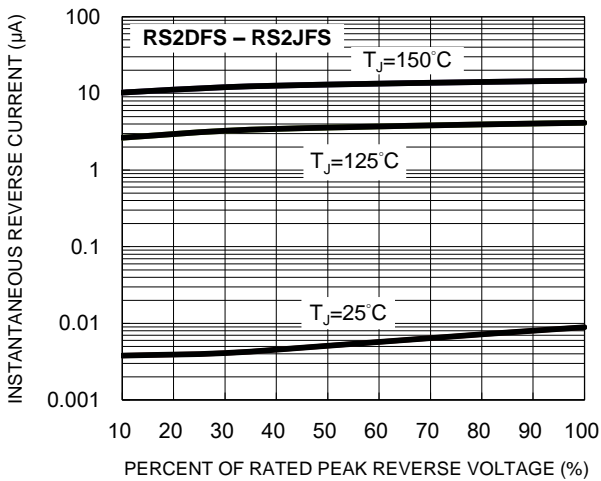
**Fig.1 Forward Current Derating Curve**



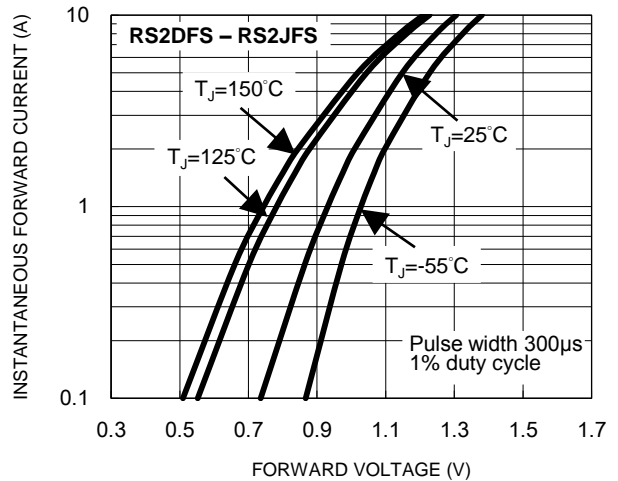
**Fig.2 Typical Junction Capacitance**



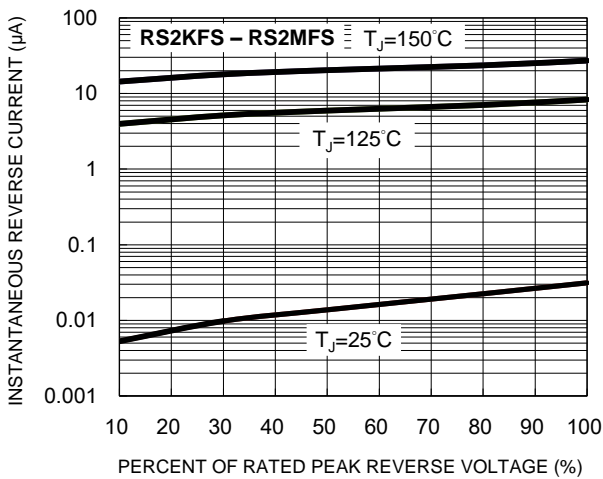
**Fig.3 Typical Reverse Characteristics**



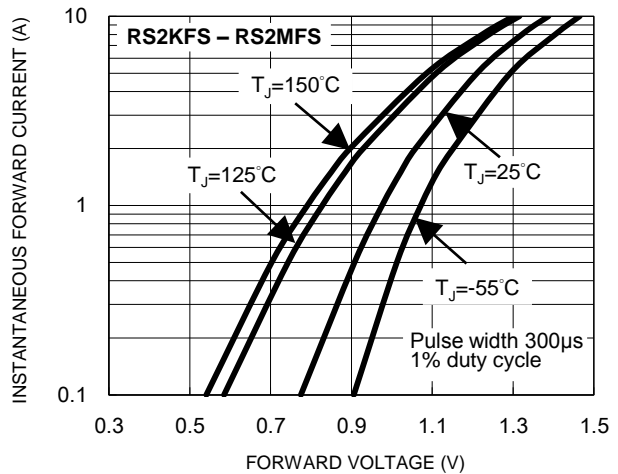
**Fig.4 Typical Forward Characteristics**



**Fig.5 Typical Reverse Characteristics**



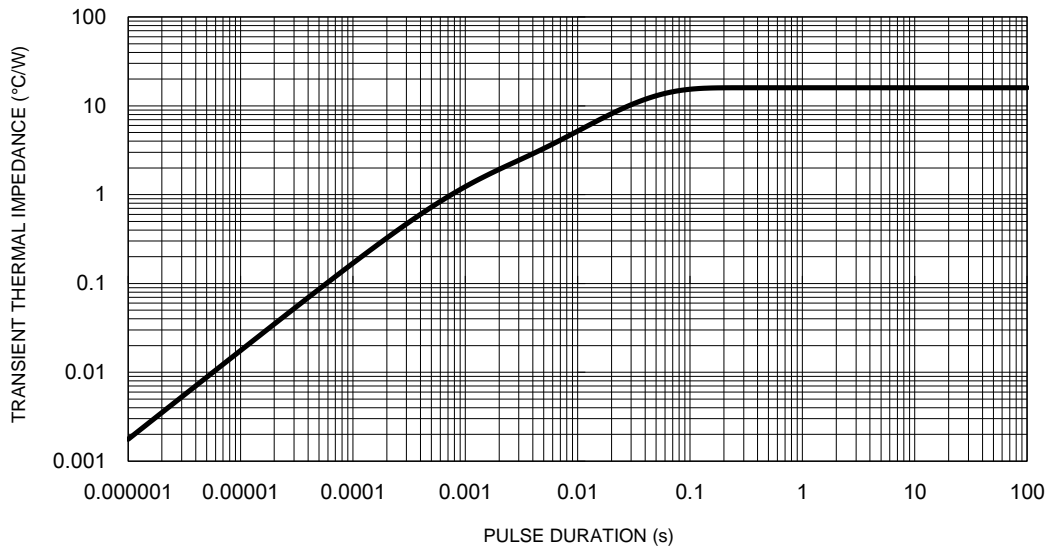
**Fig.6 Typical Forward Characteristics**



**CHARACTERISTICS CURVES**

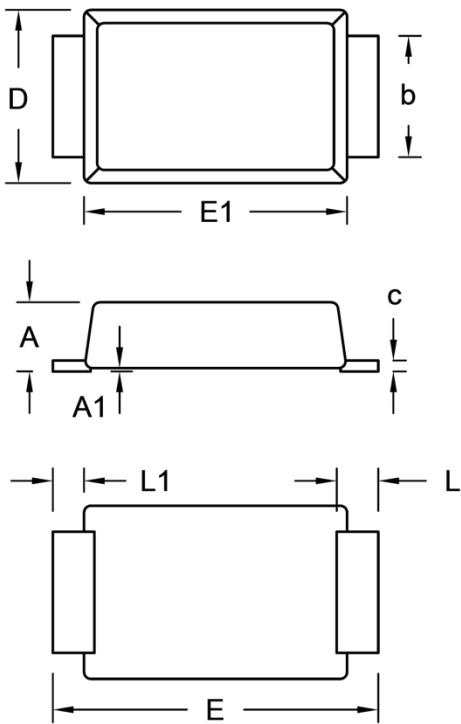
( $T_A = 25^\circ\text{C}$  unless otherwise noted)

**Fig.7 Typical Transient Thermal Impedance**



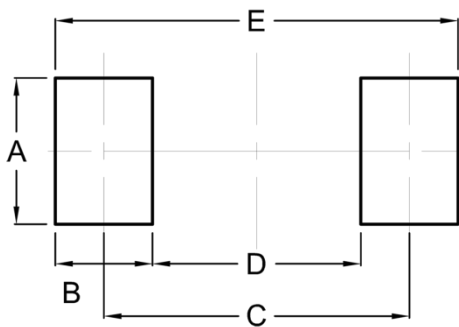
**PACKAGE OUTLINE DIMENSIONS**

SOD-128



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.10	0.035	0.043
A1	0.00	0.10	0.000	0.004
b	1.60	1.90	0.063	0.075
c	0.10	0.22	0.004	0.009
D	2.30	2.70	0.091	0.106
E	4.40	5.00	0.173	0.197
E1	3.60	4.00	0.142	0.157
L	0.40	0.80	0.016	0.031
L1	0.30	0.60	0.012	0.024

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

**MARKING DIAGRAM**



P/N = Marking Code  
 YW = Date Code  
 F = Factory Code

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